



MOSFET

OptiMOS[™]5 Power-MOSFET, 30 V

Features

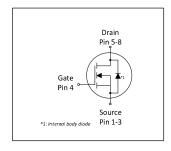
- Optimized for high performance buck converters (Server,VGA)
 Very low FOMQ_{OSS} and FOMQ_g for high frequency SMPS
 Very low on-resistance R_{DS(on)} @ V_{GS}=4.5 V
 100% avalanche tested
 Superior thermal resistance

- N-channel
- Qualified according to JEDEC¹⁾ for target applications
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

Table 1 **Kev Performance Parameters**

Parameter	Value	Unit					
V _{DS}	30	V					
R _{DS(on),max}	4.4	mΩ					
ID	61	A					
Qoss	7.2	nC					
Q _G (0V4.5V)	5.2	nC					









Type / Ordering Code	Package	Marking	Related Links
BSZ0506NS	PG-TSDSON-8 FL	0506NS	-



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1 Maximum ratings at *T*_A=25 °C, unless otherwise specified

Table 2Maximum ratings

Parameter	Cumph al		Value	/alues		
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	Ι _D	-	- - - -	61 39 56 35 15	A	$V_{GS}=10 V, T_{C}=25 °C$ $V_{GS}=10 V, T_{C}=100 °C$ $V_{GS}=4.5 V, T_{C}=25 °C$ $V_{GS}=4.5 V, T_{C}=100 °C$ $V_{GS}=4.5 V, T_{A}=25 °C, R_{thJA}=60 \text{ K/W}^{2)}$
Pulsed drain current ³⁾	I _{D,pulse}	-	-	244	А	<i>T</i> _c =25 °C
Avalanche current, single pulse ⁴⁾	I _{AS}	-	-	20	А	<i>T</i> _c =25 °C
Avalanche energy, single pulse	EAS	-	-	20	mJ	I _D =20 A, <i>R</i> _{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	27 2.1	-	w	T _C =25 °C T _A =25 °C, R _{thJA} =60 K/W
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

2 **Thermal characteristics**

Table 3 **Thermal characteristics**

Deveneter	Sumbal	Values			llmit	Note / Test Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	4.6	K/W	-
Device on PCB, 6 cm ² cooling area ⁴⁾	R _{thJA}	-	-	60	K/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. ²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain

connection. PCB is vertical in still air.

³⁾ See figure 3 for more detailed information ⁴⁾ See figure 13 for more detailed information



3 Electrical characteristics at *T*_j=25 °C, unless otherwise specified

Table 4 **Static characteristics**

Devenue te v	Symphol		Values			Note / Toot Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	30	-	-	V	V _{GS} =0 V, <i>I</i> _D =1 mA
Gate threshold voltage	V _{GS(th)}	1.2	1.6	2	V	V _{DS} =V _{GS} , <i>I</i> _D =250 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =24 V, V _{GS} =0 V, T _j =25 °C V _{DS} =24 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	4.4 3.5	5.3 4.4	mΩ	V _{GS} =4.5 V, <i>I</i> _D =20 A V _{GS} =10 V, <i>I</i> _D =20 A
Gate resistance	R _G	-	1	1.7	Ω	-
Transconductance	$g_{ m fs}$	49	98	-	S	V _{DS} >2 I _D R _{DS(on)max} , I _D =30 A

Table 5Dynamic characteristics

Demonster	Course has a	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	700	950	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	220	300	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Reverse transfer capacitance	C _{rss}	-	16	-	pF	V _{GS} =0 V, V _{DS} =15 V, <i>f</i> =1 MHz
Turn-on delay time	t _{d(on)}	-	2.3	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	tr	-	2.4	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{\rm d(off)}$	-	13	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	2.0	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics²⁾

Deveryor	C. maked	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	1.9	-	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate charge at threshold	Q _{g(th)}	-	1.1	-	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate to drain charge	Q _{gd}	-	1.4	-	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Switching charge	Qsw	-	2.2	-	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate charge total	Qg	-	5.2	7.2	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.7	-	V	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 4.5 V
Gate charge total	Qg	-	11	15	nC	V_{DD} =15 V, I_{D} =30 A, V_{GS} =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	4.8	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 4.5 V
Output charge	Qoss	-	7.2	-	nC	V _{DD} =15 V, V _{GS} =0 V

¹⁾ Defined by design. Not subject to production test.
²⁾ See "Gate charge waveforms" for parameter definition

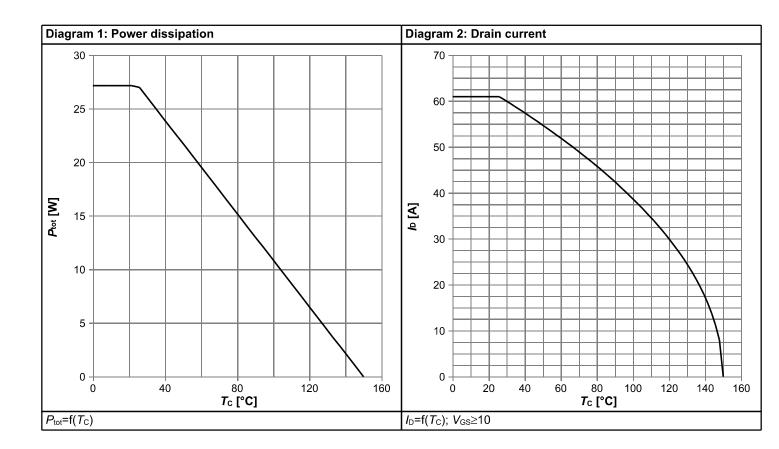


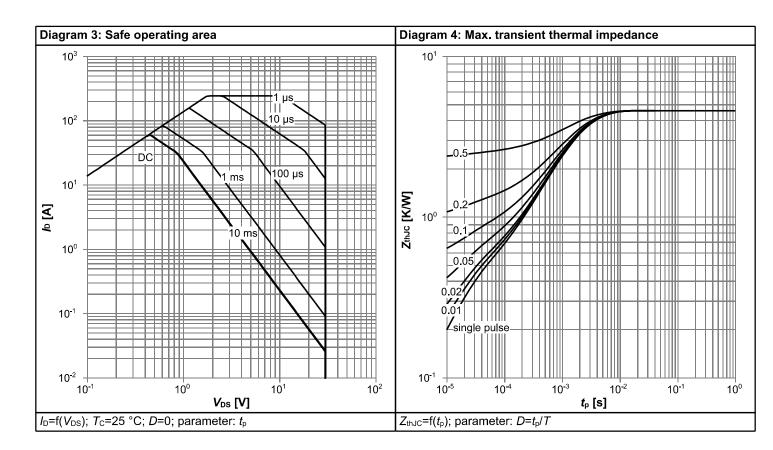
Table 7Reverse diode

Parameter	Symbol		Values			Note / Toot Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	24	A	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	244	A	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.81	1.1	V	V _{GS} =0 V, <i>I</i> _F =20 A, <i>T</i> _j =25 °C
Reverse recovery charge	Q _{rr}	-	10	-	nC	V _R =15 V, <i>I</i> _F =30A, d <i>i</i> _F /d <i>t</i> =400 A/μs

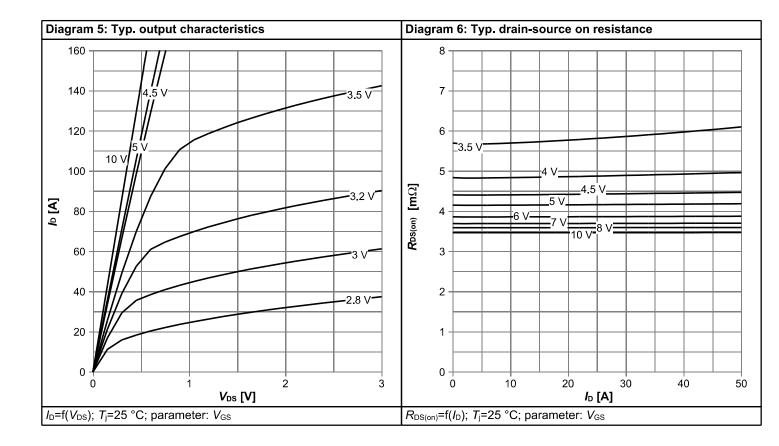


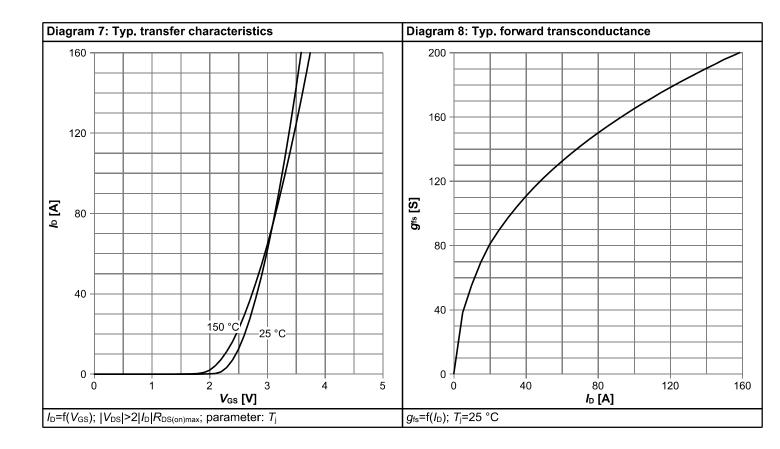
4 Electrical characteristics diagrams



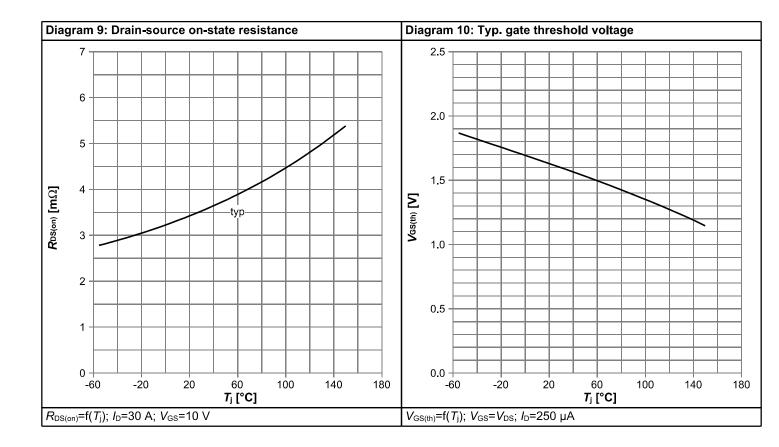


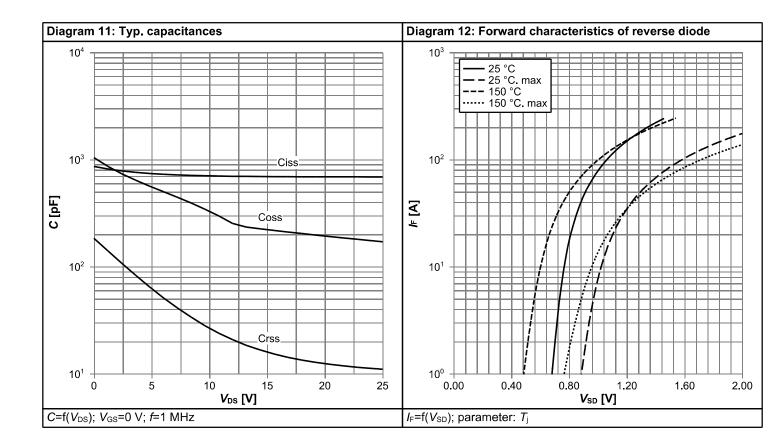




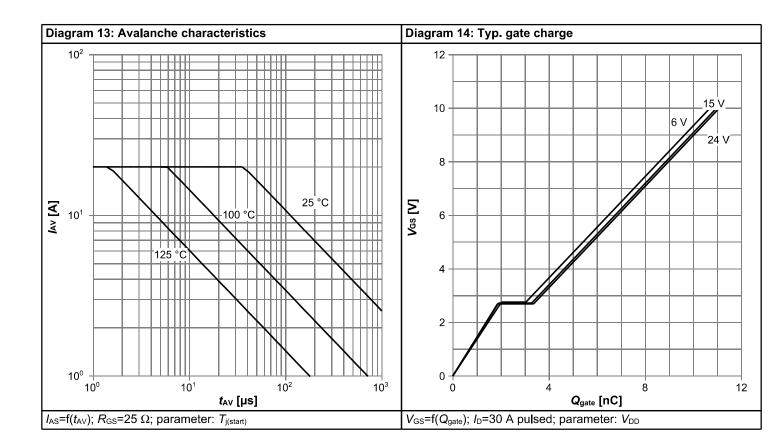


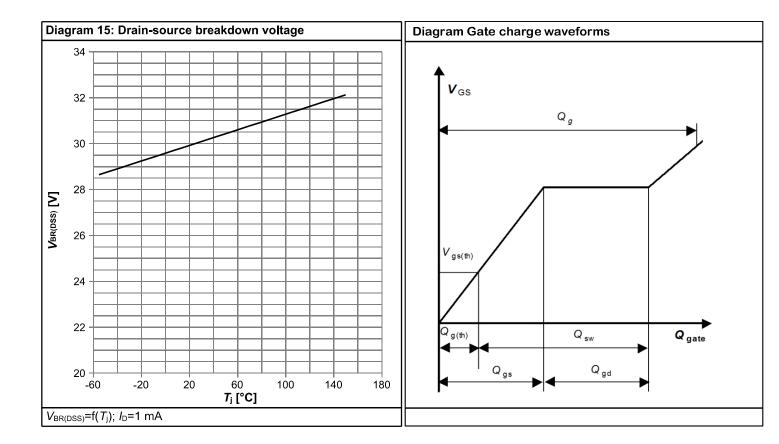






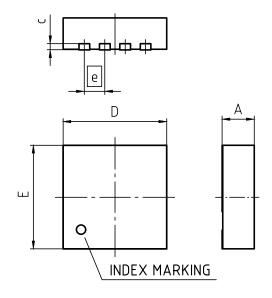


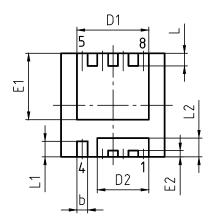






5 Package Outlines





PACKAGE - GROUP NUMBER:	ON-8-U03					
REVISION: 03	DATE:	20.10.2020				
DIMENSIONS	MILLIM	ETERS				
DIMENSIONS	MIN.	MAX.				
A	0.90	1.10				
b	0.24	0.44				
c	(0.20)					
D	3.20	3.40				
D1	2.19	2.39				
D2	1.54	1.74				
E	3.20	3.40				
E1	2.01	2.21				
E2	0.10	0.30				
е	0.65					
L	0.30	0.50				
L1	0.40 0.60					
L2	0.50 0.70					
aaa	0.0)6				

Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm



Revision History

BSZ0506NS

Revision: 2021-02-16, Rev. 2.2

Previous Revision							
Revision	Date	Subjects (major changes since last revision)					
2.0	2015-04-27	Release of final version					
2.1	2020-11-20	Update package drawing					
2.2	2021-02-16	Update Max Id current rating					

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